



# a silicon tracker for ILD ?

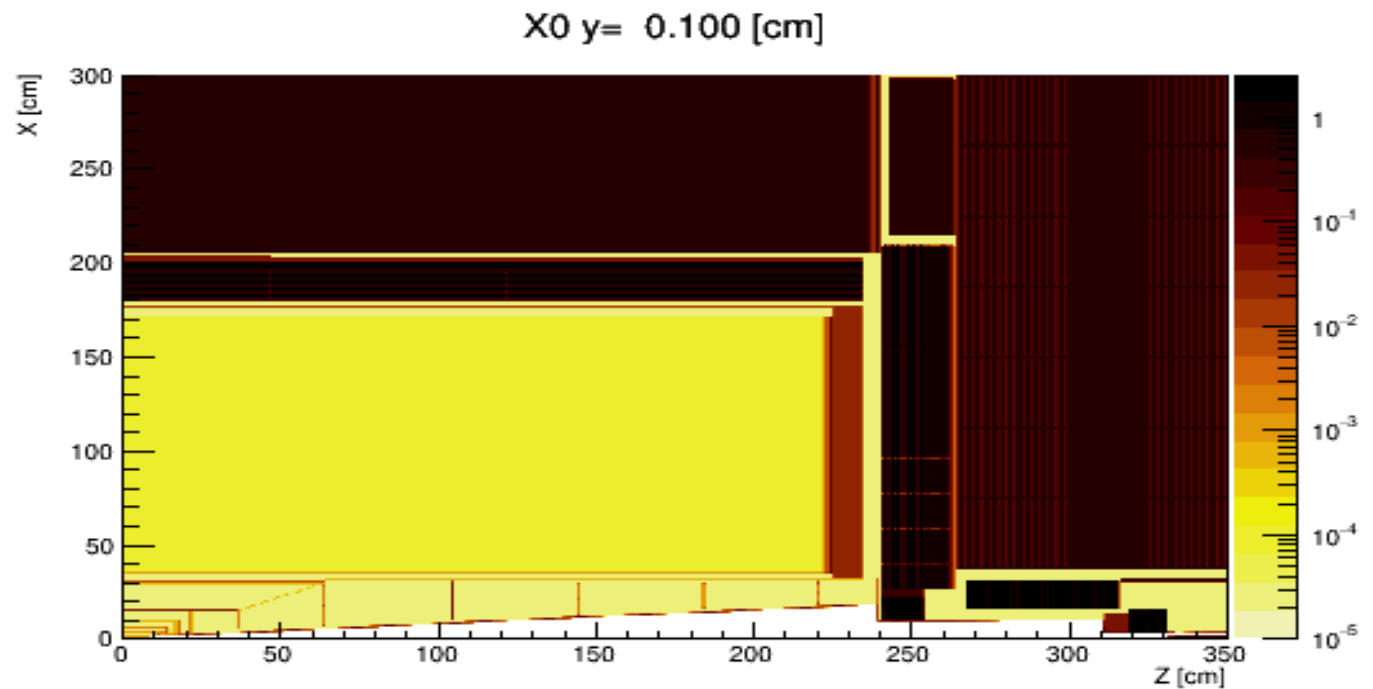
replacing ILD's TPC with a  
CLIC-like silicon tracker  
(in simulation)

Daniel Jeans, KEK/IPNS

ILC detector meeting, 2022/3/9



Institute of Particle and  
Nuclear Studies



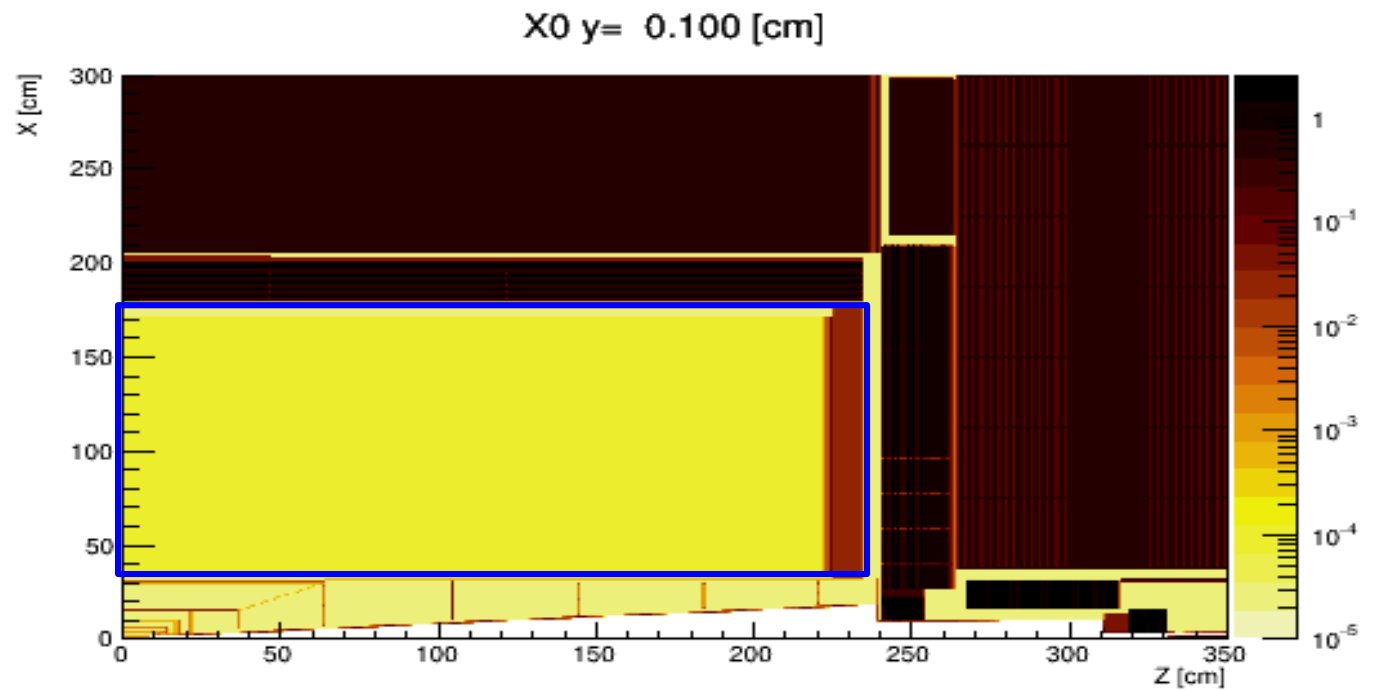
ILD's simulation model is designed to make it easy to compare technologies

e.g. \* "hybrid calorimeters" → simultaneous simulation of silicon/scintillator ECAL  
 scintillator/RPC HCAL

\* Large and Small versions of ILD

These can help us to decide which technology is better  
 change just one detector part; most of detector is identical  
 same events  
 same reconstruction algorithms (or possibly some adaptation)

→ detector optimisation



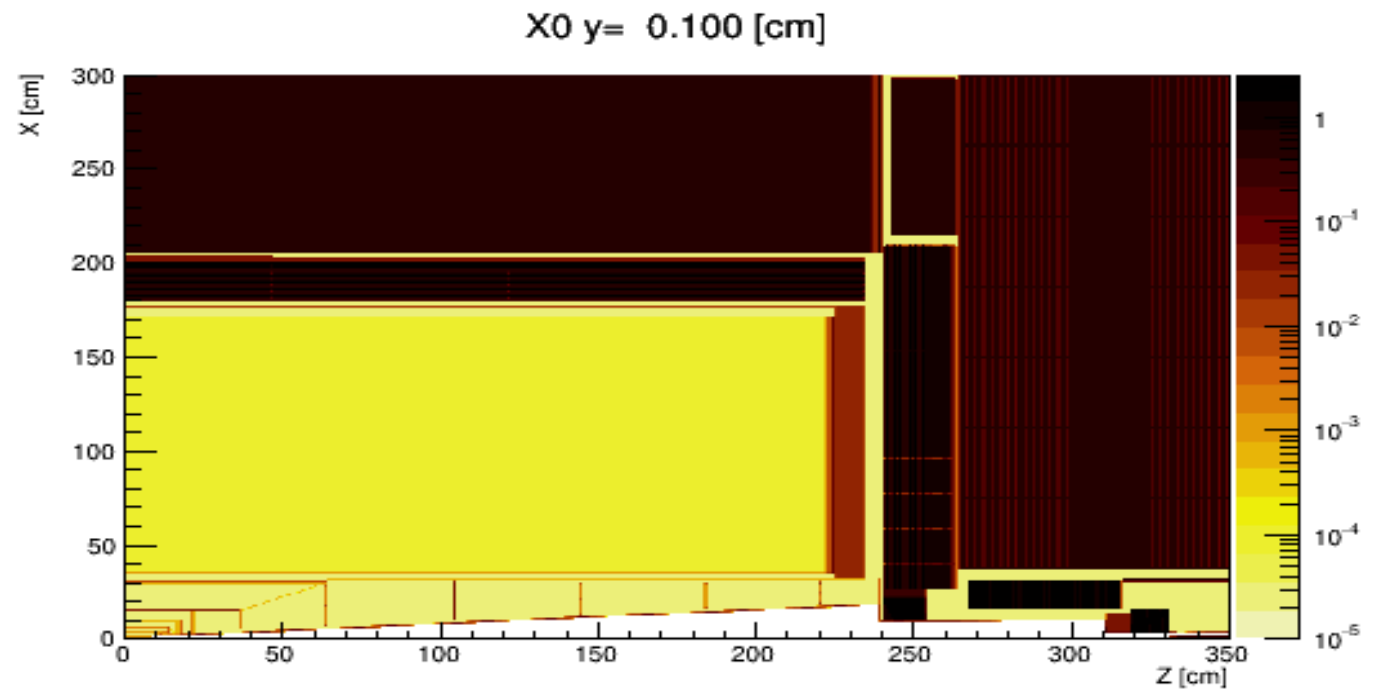
in this talk, I'll describe a new model which replaces the TPC (and SET)  
with an all-silicon tracker

when is TPC better ?

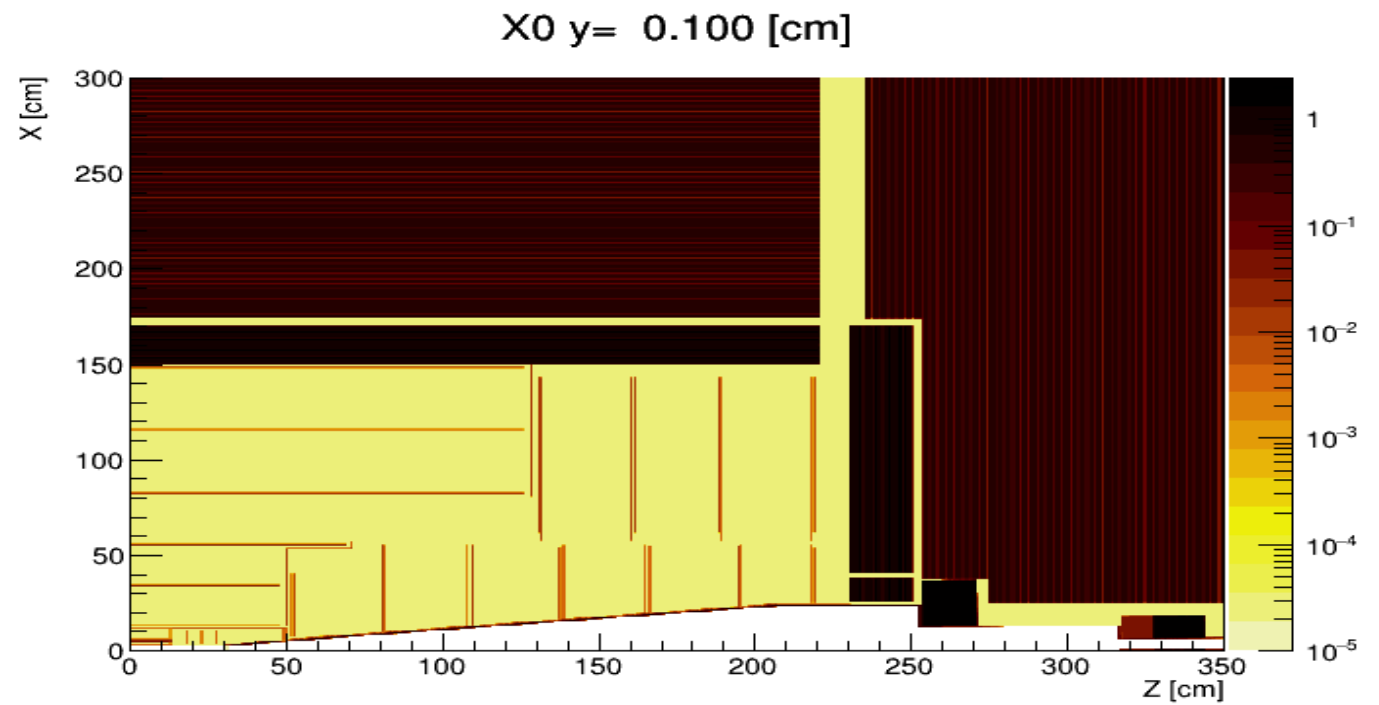
does all-silicon tracker have any advantages?

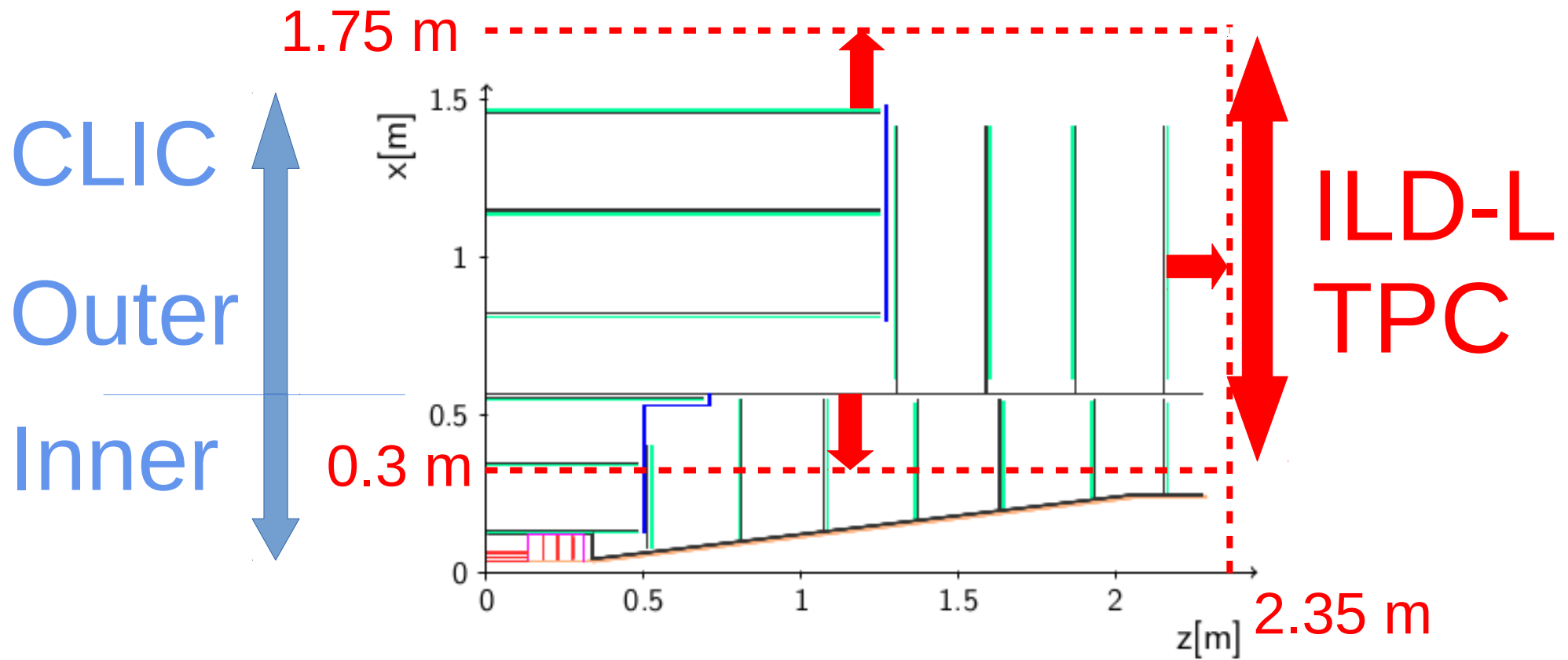
how about at other Higgs factories ?

ILD\_I5\_v02



CLIC\_o3\_v14





replace ILD-L's TPC+SET with CLIC-like outer silicon tracker

\* radial size significantly larger: 1 additional barrel layer wrt CLIC

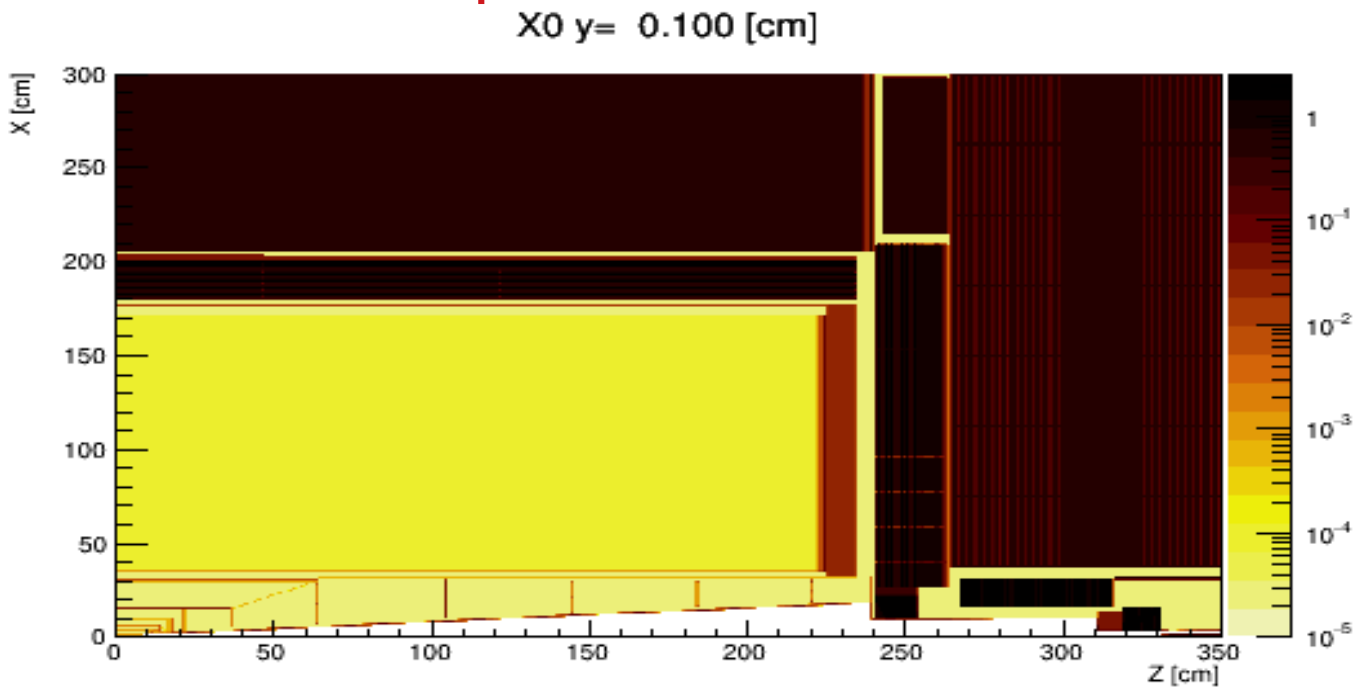
\* length similar:

same tracker barrel → endcap disk transition position ~ 1.25m  
slightly more separated endcap disks

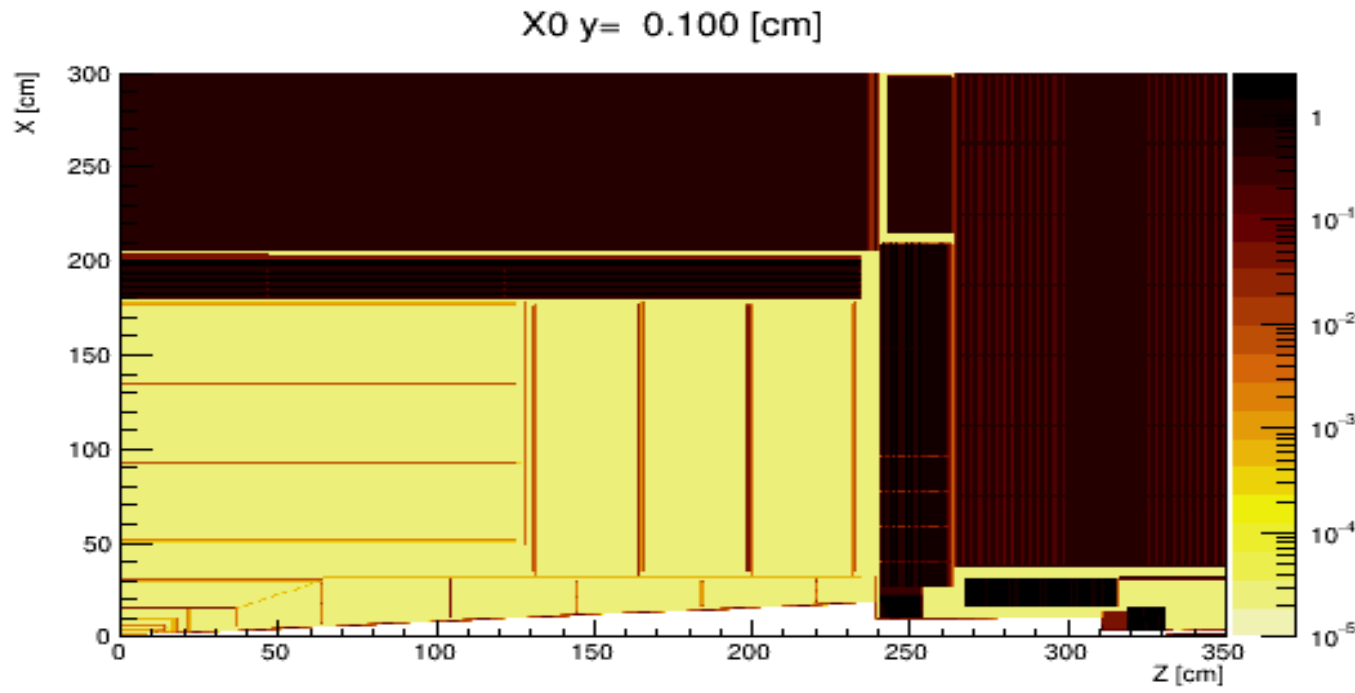
[ I am not a tracking expert, so this is probably not optimal  
→ very happy to receive suggestions! ]

# geometry implemented in DD4hep

ILD\_I5\_v02

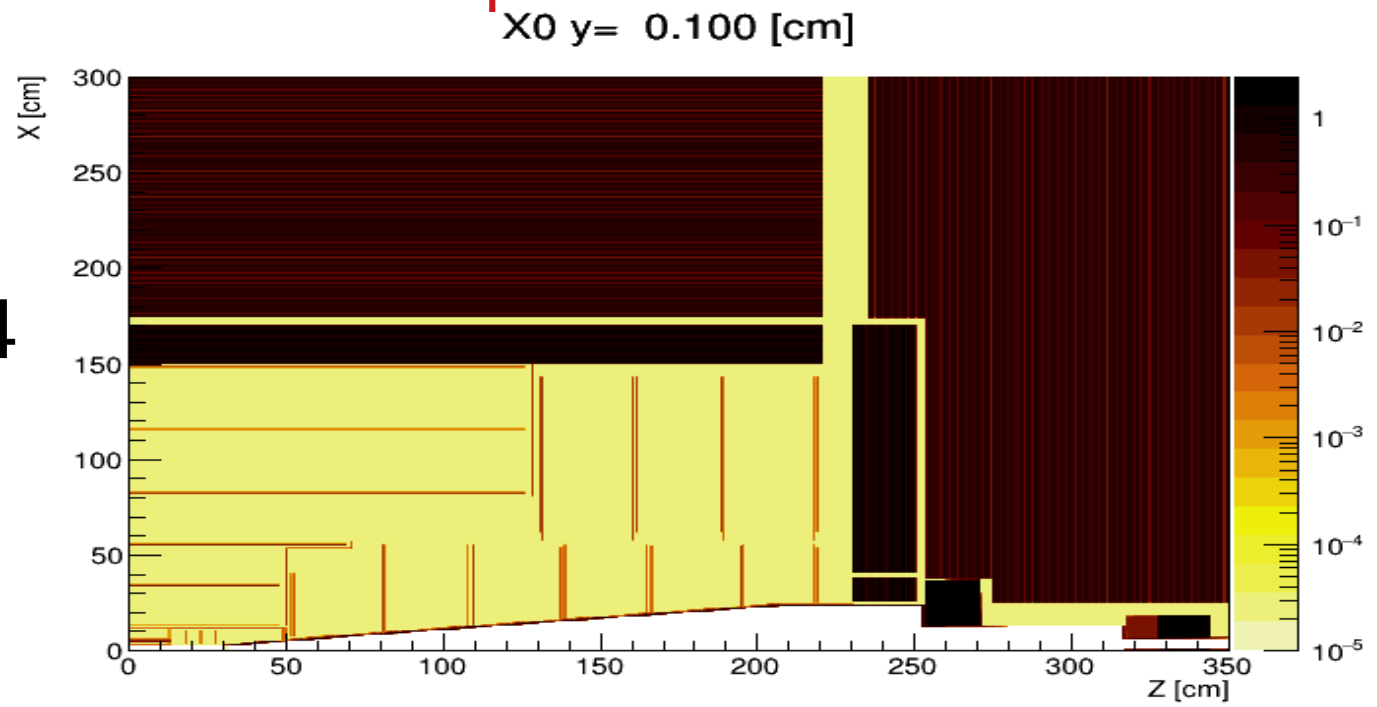


ILD\_I5\_v09

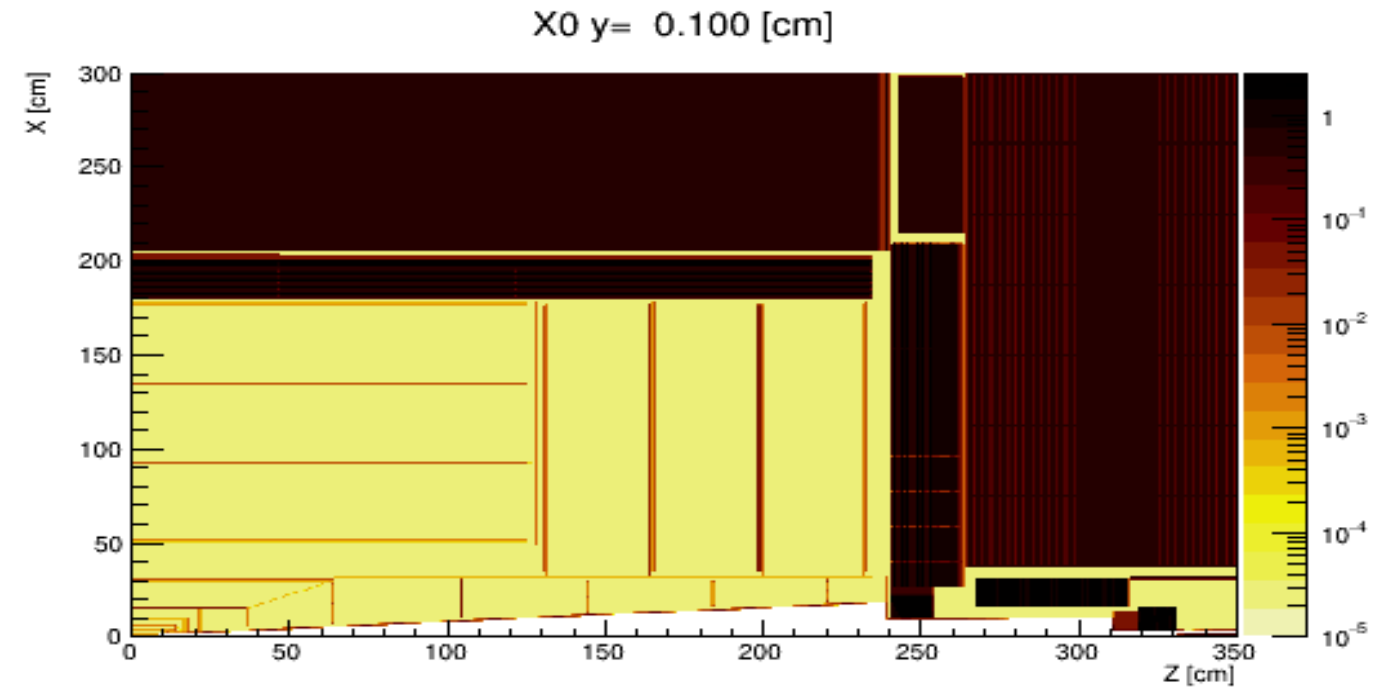


# geometry implemented in DD4hep

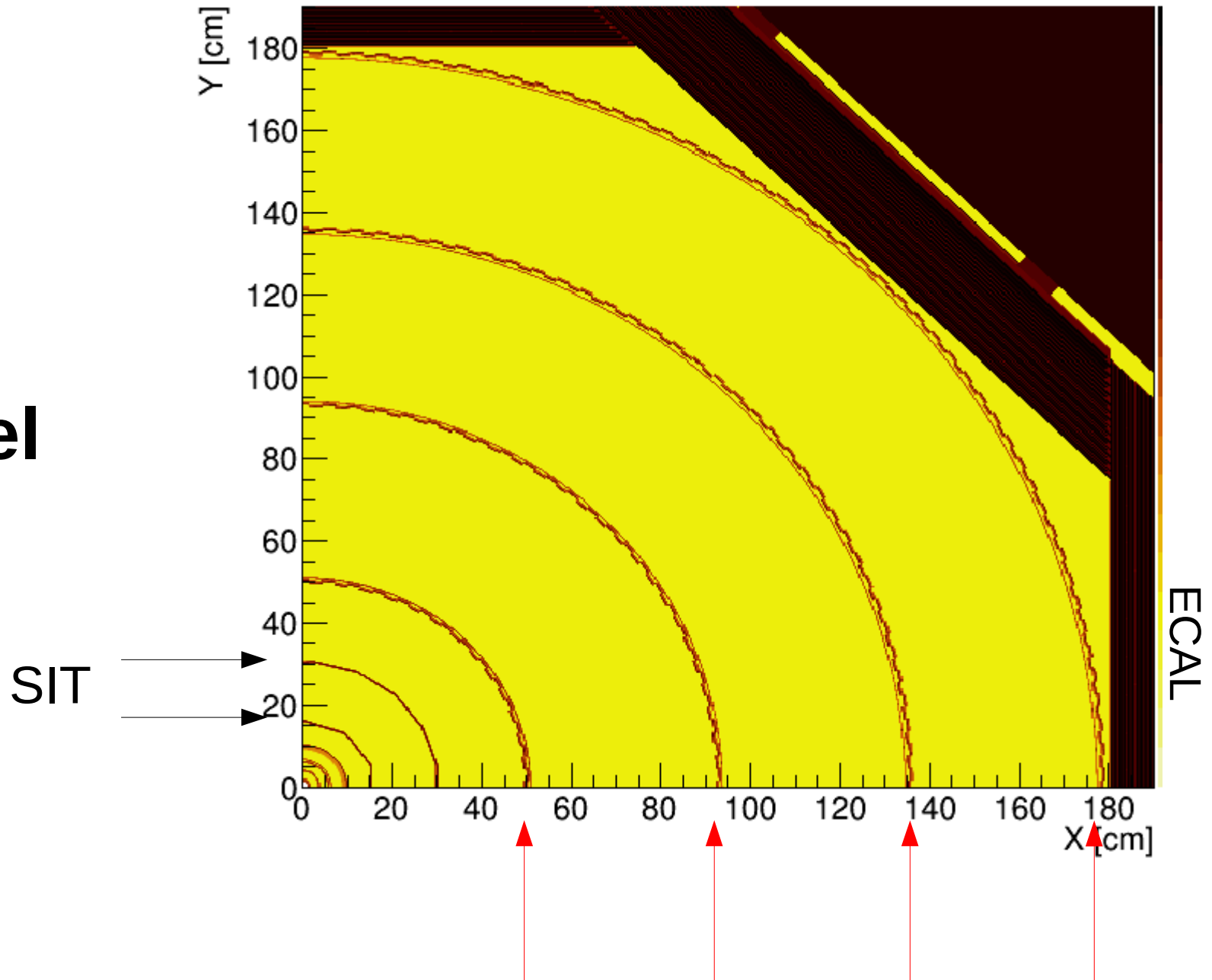
CLIC\_o3\_v14



ILD\_I5\_v09



**barrel**

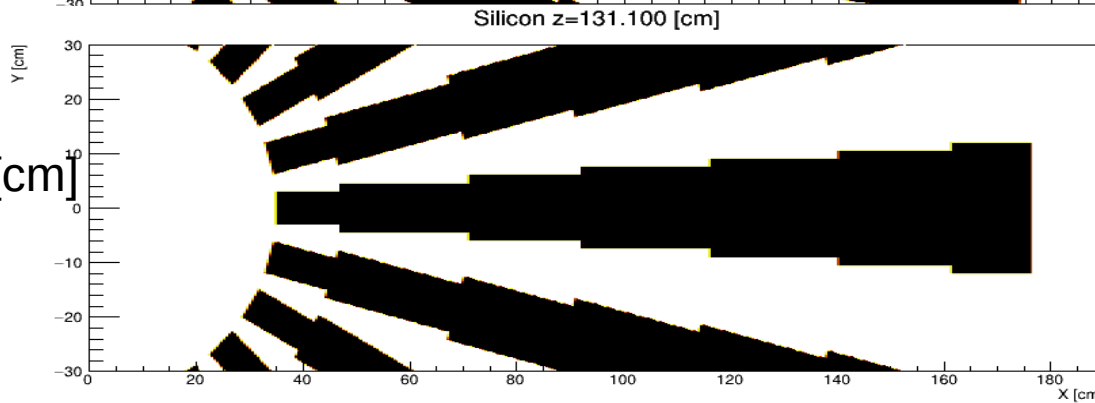
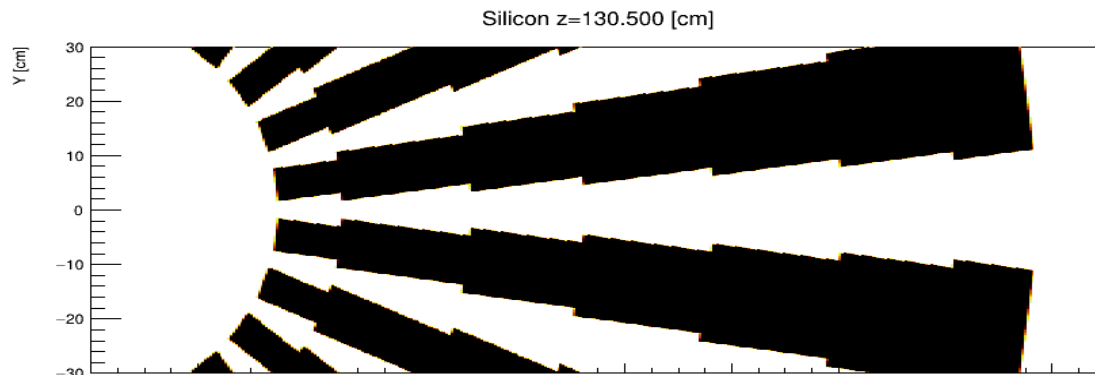
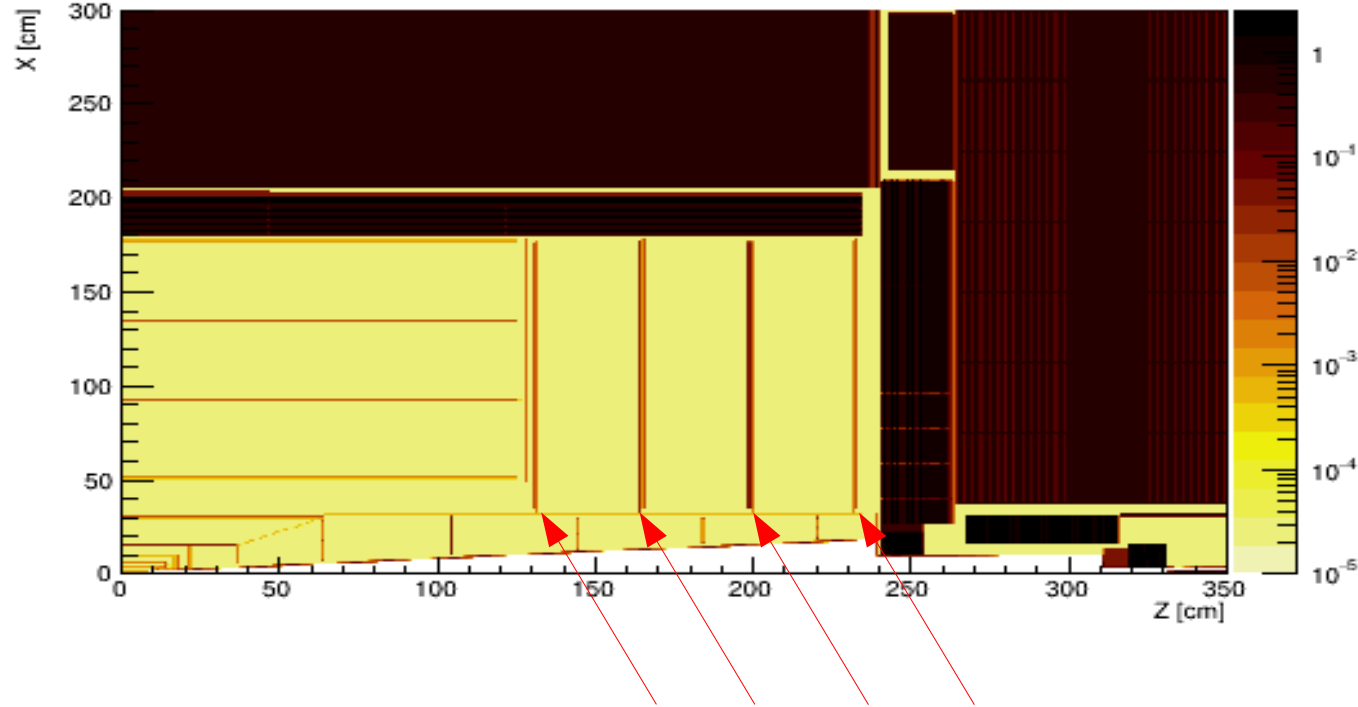


4 barrel layers, made up of small sensors



## endcap

pairs of endcap disks,  
48 petals per disk  
disks offset in phi to  
completely cover



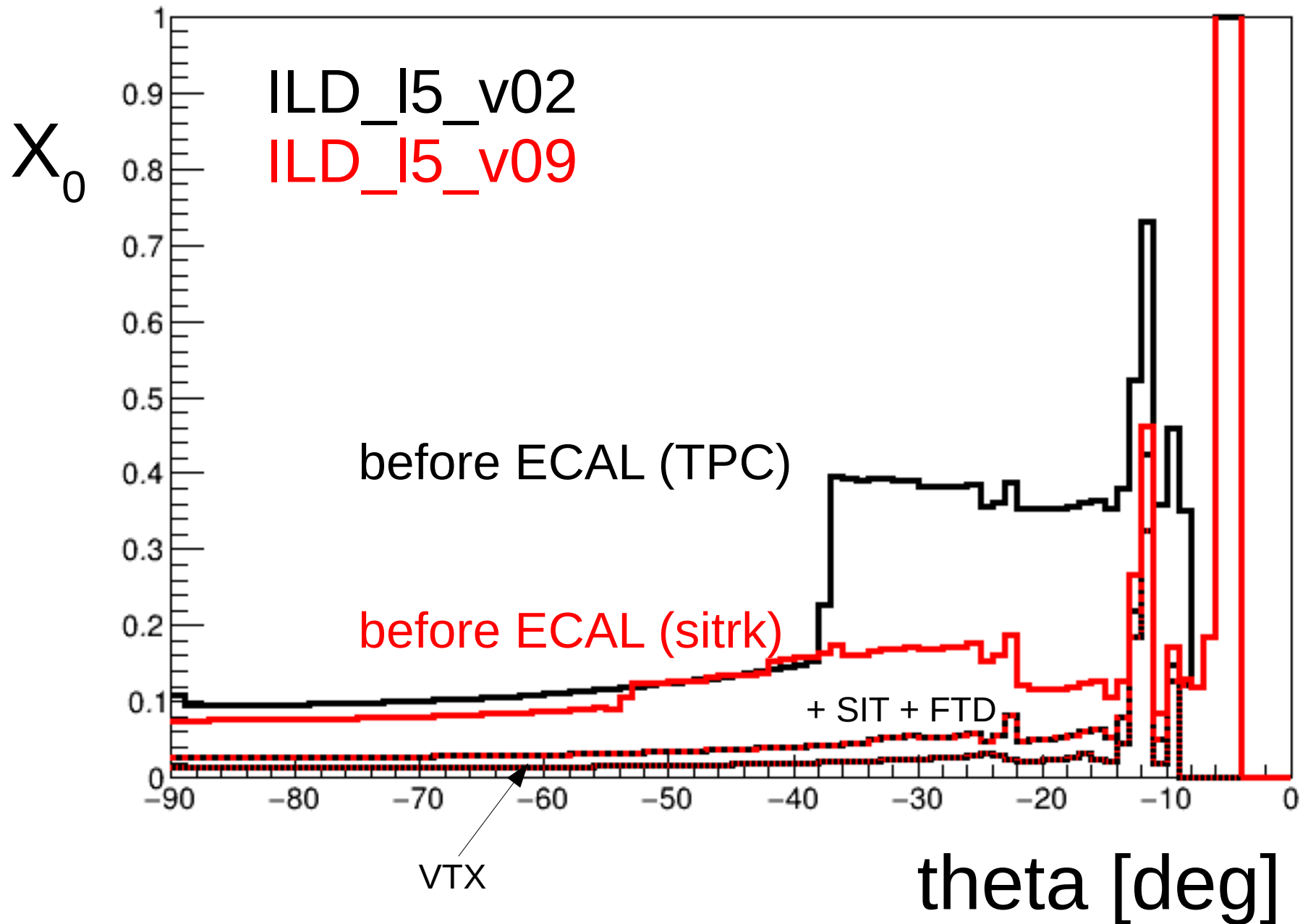
X [cm]

180 cm

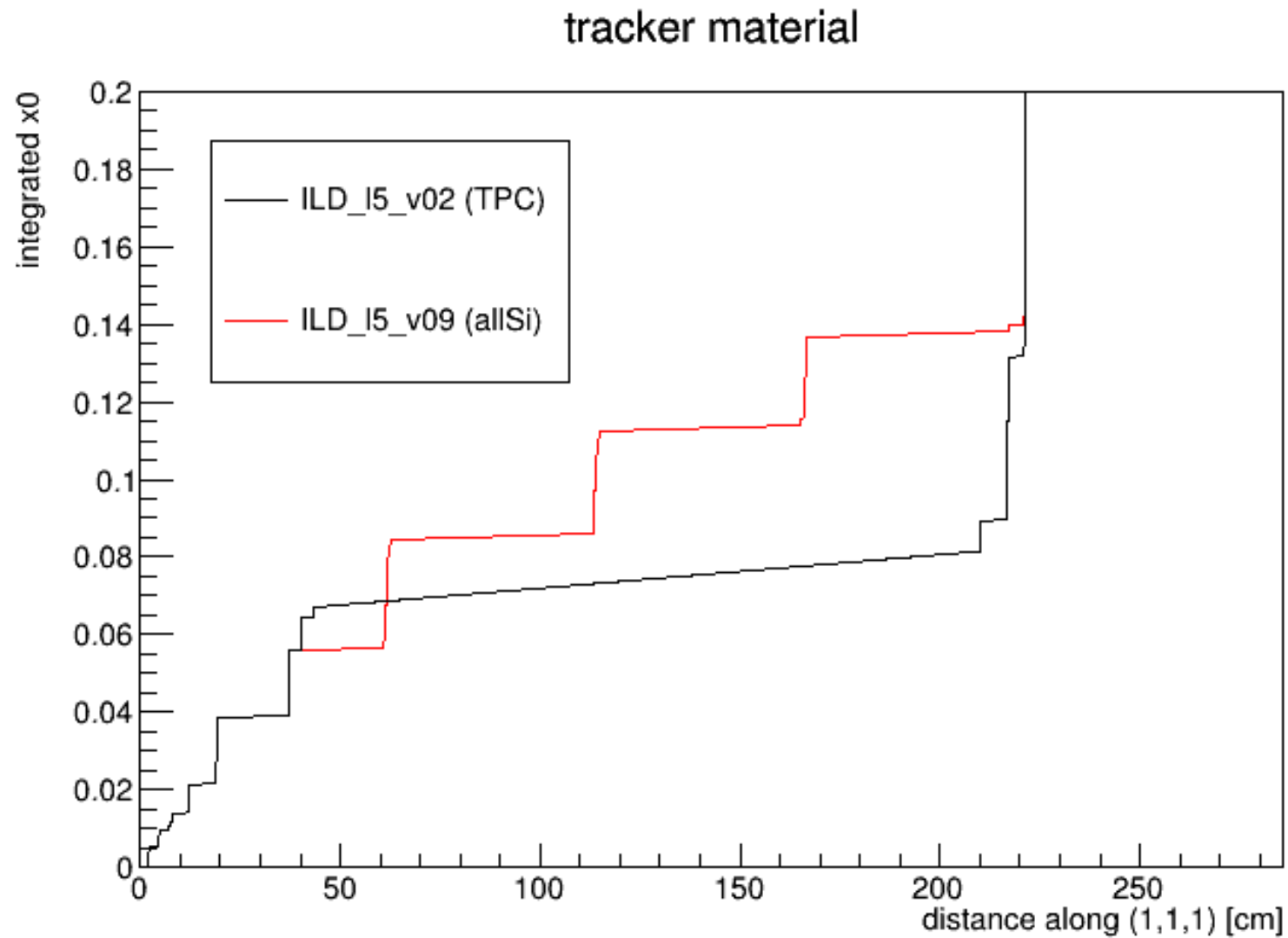
4 endcap disk pairs

each petal is a mosaic  
of 30x30 mm<sup>2</sup> sensors;  
just enough to cover

# compare material budget (along y=0)

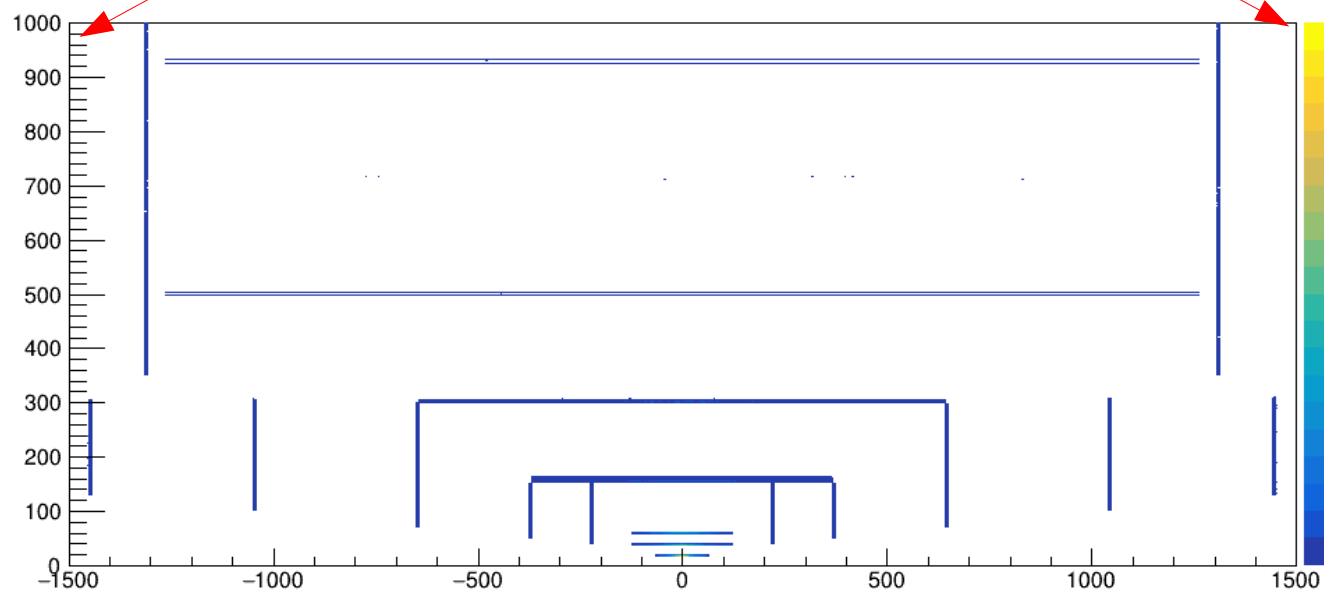
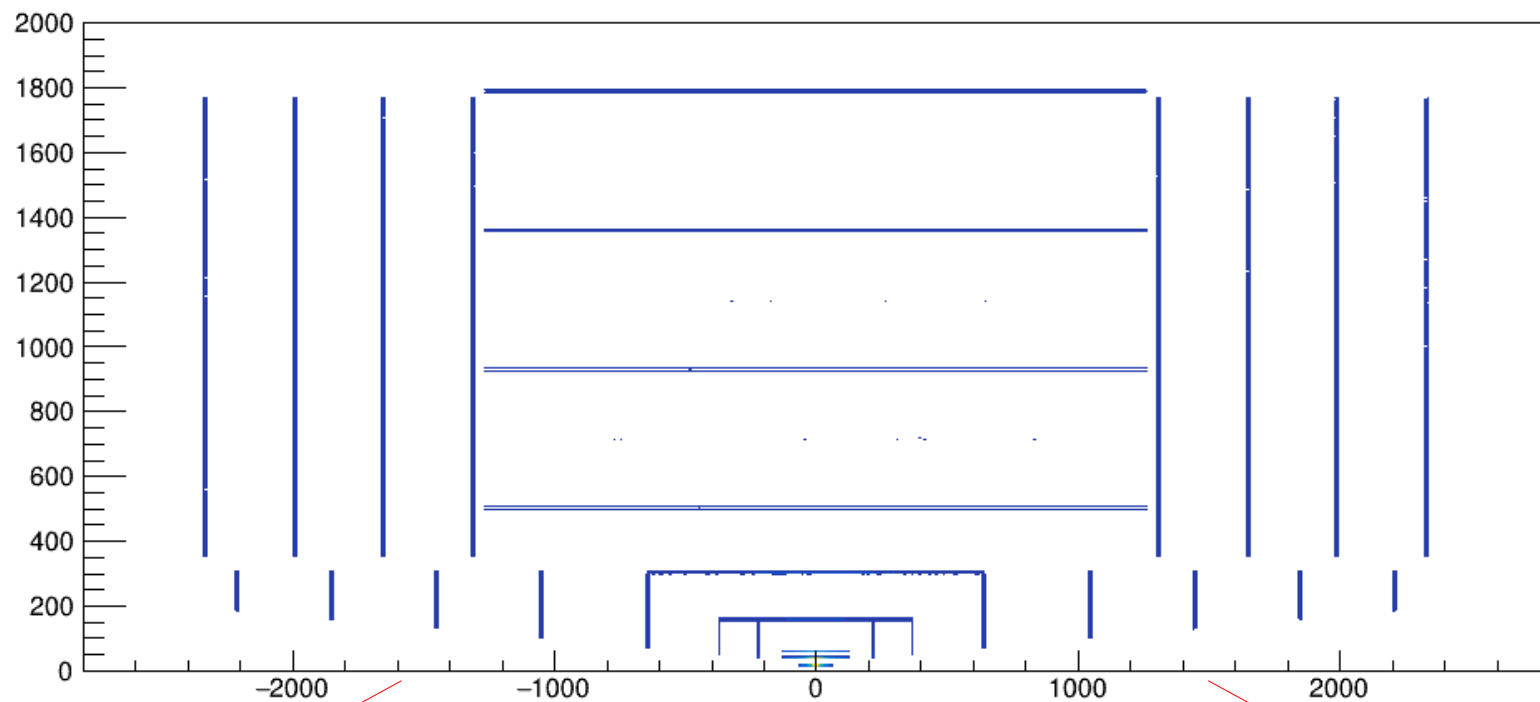


# compare material budget (along $x=y=z$ )



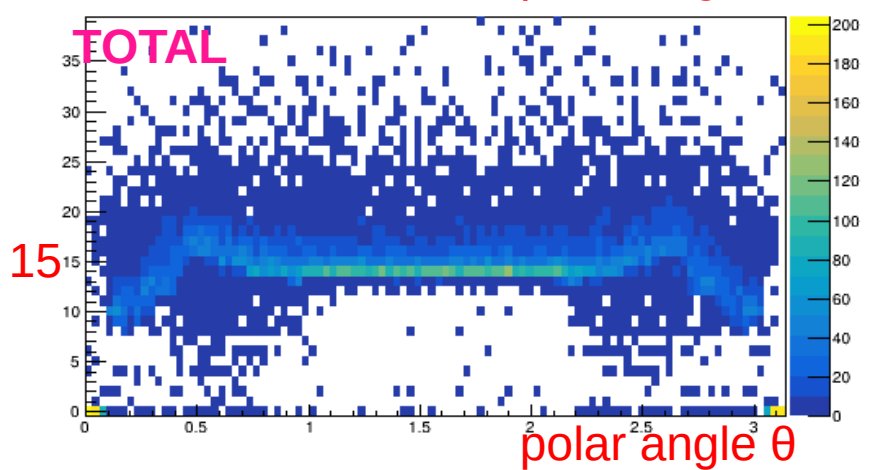
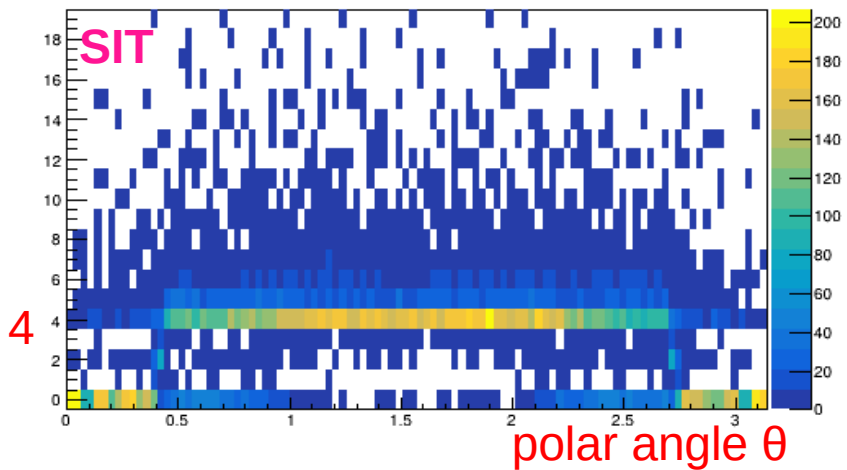
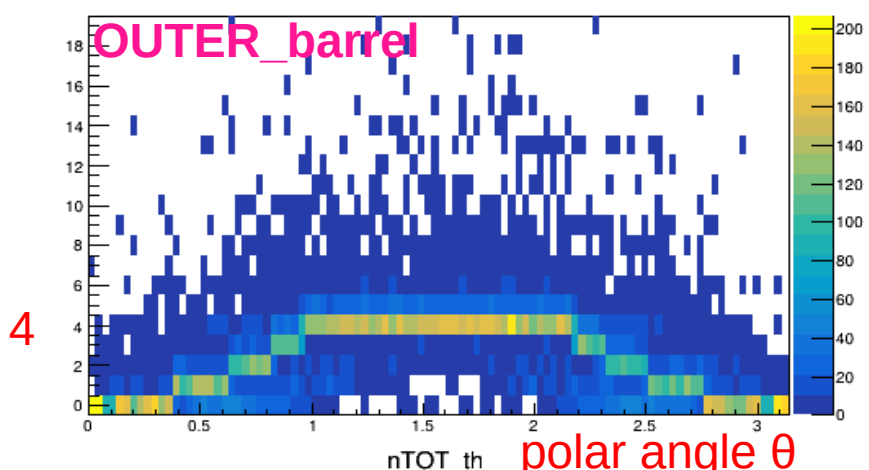
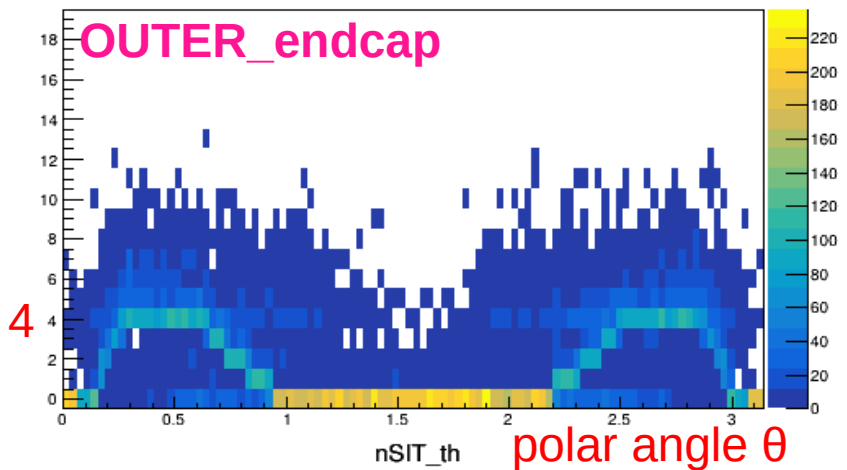
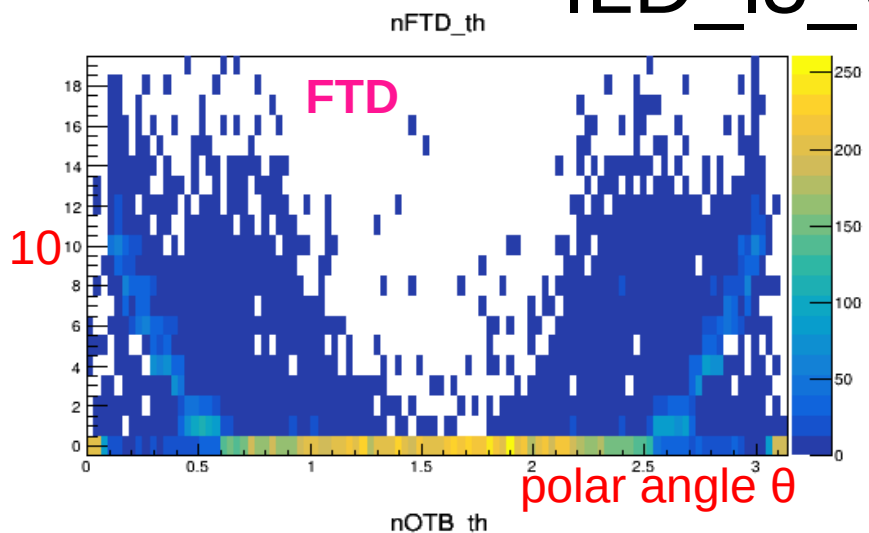
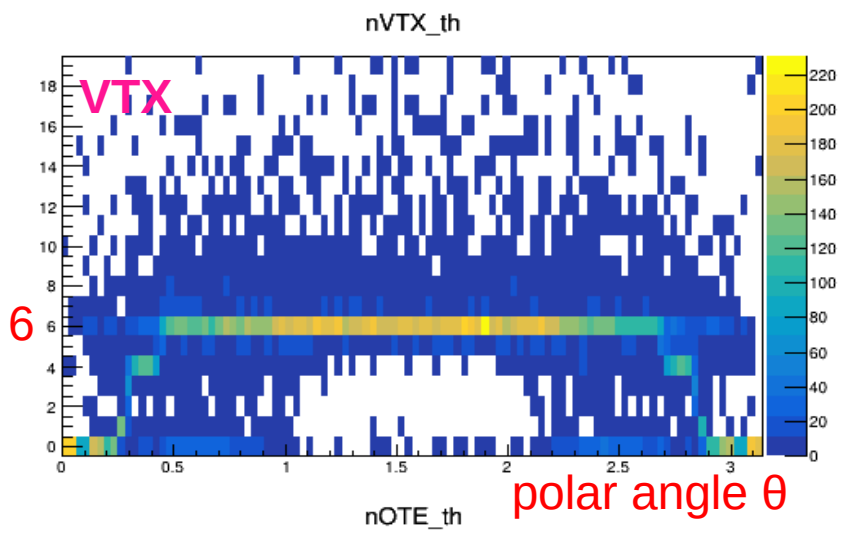
# tracker hit map

ILD\_I5\_v09



# tracker hits [ 20k 50GeV mu-, flat in theta & phi ]

ILD\_I5\_v09



# summary

ILD model with si-only tracker  
outer tracker adapted from CLICdp design

comments on design very welcome  
(especially from tracking experts)

simulation technically works ; pull request to lcgeo pending

if people are interested:

- adjust model according to your suggestions
- reconstruction (conformal tracking as at CLIC?)
- comparison @ single particle, physics analysis

backup

based on OuterTracker\_o2\_v06\_01.xml (used in e.g. CLIC\_o3\_v14)

which uses TrackerBarrel\_o1\_v05  
TrackerEndcap\_o2\_v06  
TrackerBarrelSupport\_o1\_v01  
TrackerEndcapSupport\_o1\_v01

some of the parameters:

```
<constant name="OuterTracker_Barrel_radius_0" value="500*mm"/>
<constant name="OuterTracker_Barrel_radius_MAX" value="TPC_outer_radius+Ecal_Tpc_gap-20*mm"/>
<constant name="OuterTracker_Barrel_radius_GAP" value="(1./3.)*(OuterTracker_Barrel_radius_MAX -
    OuterTracker_Barrel_radius_0)"/>

<constant name="OuterTracker_Barrel_radius_1" value="OuterTracker_Barrel_radius_0 +
    OuterTracker_Barrel_radius_GAP"/>
<constant name="OuterTracker_Barrel_radius_2" value="OuterTracker_Barrel_radius_1 +
    OuterTracker_Barrel_radius_GAP"/>
<constant name="OuterTracker_Barrel_radius_3" value="OuterTracker_Barrel_radius_MAX"/>

<constant name="OuterTracker_Barrel_half_length" value="1264.2*mm"/>

<constant name="OuterTracker_Endcap_outer_radius" value="OuterTracker_Barrel_radius_MAX"/>
<constant name="OuterTracker_Endcap_inner_radius" value="350*mm"/>

<constant name="OuterTracker_Endcap_z_0" value="1310*mm"/>
<constant name="OuterTracker_Endcap_z_1" value="1650*mm"/>
<constant name="OuterTracker_Endcap_z_2" value="1990*mm"/>
<constant name="OuterTracker_Endcap_z_3" value="2330*mm"/>
```



# si tracker module:

0.100*mm	Kapton	Power bus: Insulating layer
0.200*mm	Aluminium	Power bus: Conductor
0.100*mm	Kapton	Power bus: Insulating layer
0.100*mm	Epoxy	Glue: Eccobond
0.050*mm	Kapton	Module: FPC insulating layer
0.050*mm	Aluminium	Module: FPC metal layer
0.050*mm	Kapton	Module: FPC insulating layer
0.100*mm	Silicon	Module: r/o ASIC
0.100*mm	Silicon	Module: Sensor
0.100*mm	Epoxy	Glue: Eccobond
0.150*mm	CarbonFiber	Structure and cooling: CF Skins
0.025*mm	CarbonFiber	Structure and cooling: Interface
0.100*mm	Epoxy	Structure and cooling: Glue layer
0.235*mm	Water	Structure and cooling: Cooling fluid
0.068*mm	Kapton	Structure and cooling: Cooling Pipe
0.700*mm	Allcomp_K9	Structure and cooling: Carbon Foam
2.800*mm	Rohacell_IG51	Structure and cooling: Core
0.100*mm	Epoxy	Structure and cooling: Glue layer
0.025*mm	CarbonFiber	Structure and cooling: Interface
0.150*mm	CarbonFiber	Structure and cooling: CF Skins

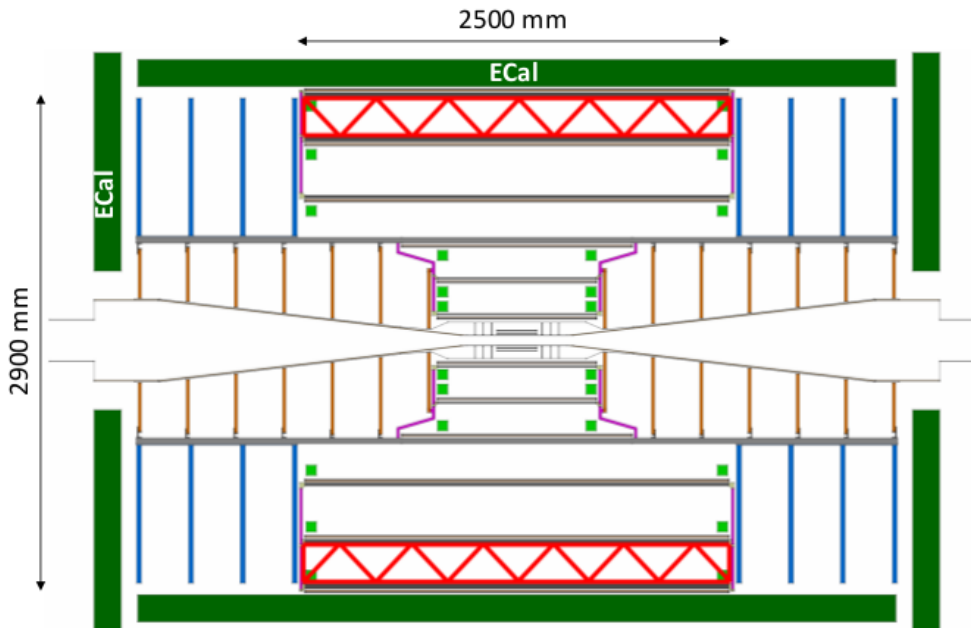
```

+-----+
+ Material scan between: x_0 = ( 40.00, 0.00, 131.00) [cm]
                        and x_1 = ( 40.00, 0.00, 135.00) [cm] :
+-----+

```

Material Num. \ Name Layer \	Thickness [cm]	Integrated X0 [cm]	
1 Air	0.035	0.000001	
2 Kapton	0.010	0.000354	← module start
3 Aluminium	0.020	0.002602	
4 Kapton	0.010	0.002954	
5 Epoxy	0.010	0.003271	
6 Kapton	0.005	0.003447	
7 Aluminium	0.005	0.004009	
8 Kapton	0.005	0.004185	
9 Silicon	0.010	0.005253	
10 Silicon	0.010	0.006320	
11 Epoxy	0.010	0.006637	
12 CarbonFiber	0.015	0.007161	
13 CarbonFiber	0.003	0.007249	
14 Epoxy	0.010	0.007565	
15 Water	0.024	0.008217	
16 Kapton	0.007	0.008456	
17 Allcomp_K9	0.070	0.008823	
18 Rohacell_IG51	0.280	0.009168	
19 Epoxy	0.010	0.009484	
20 CarbonFiber	0.003	0.009572	
21 CarbonFiber	0.015	0.010096	← module end: 1% X0
22 Air	0.384	0.010109	
23 Air	0.051	0.010110	
24 CarbonFiber	0.102	0.013659	← CF support
25 Air	0.051	0.013660	
26 Air	2.848	0.013754	
0 Average Material	4.000	0.013754	

## Tracker layout

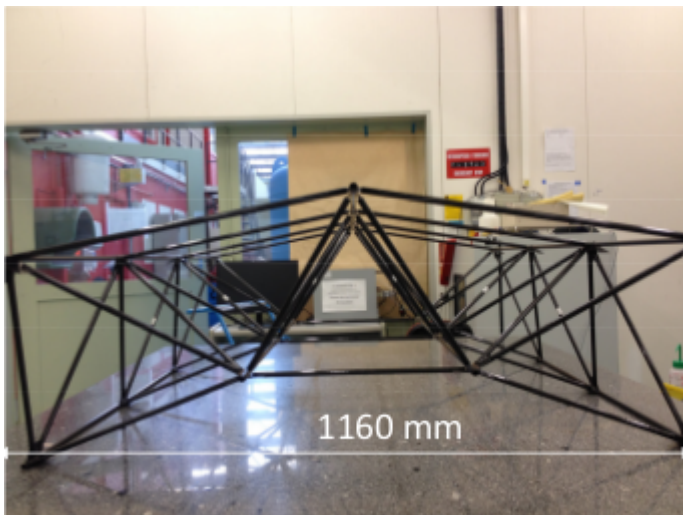
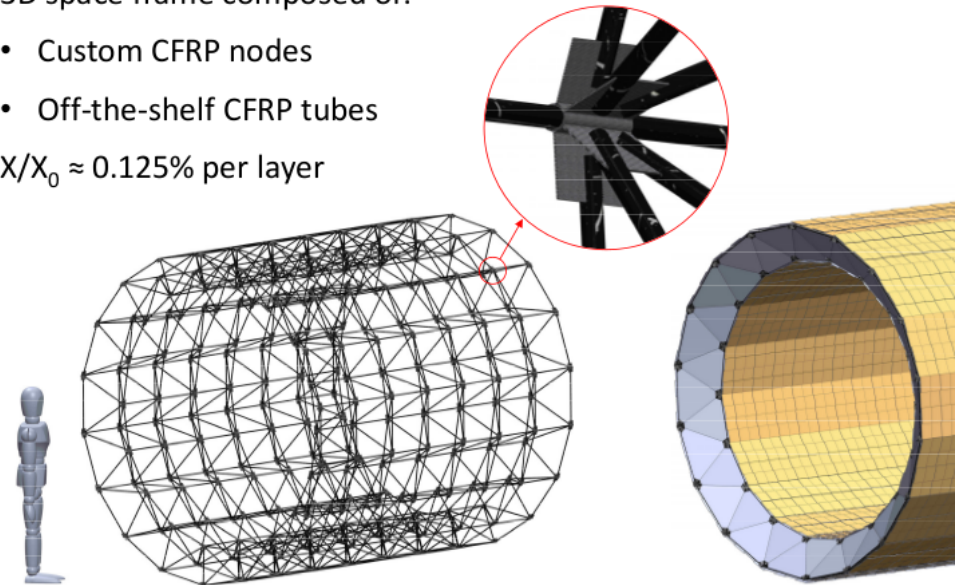


## Outer barrel support structure concept

3D space frame composed of:

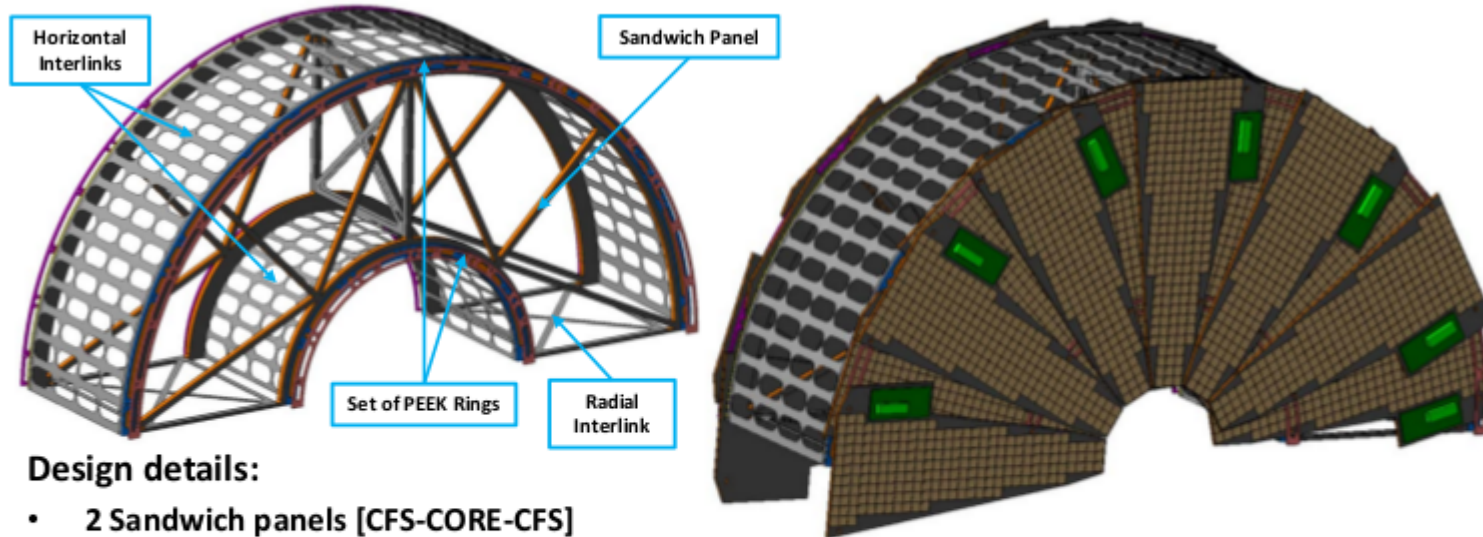
- Custom CFRP nodes
- Off-the-shelf CFRP tubes

$X/X_0 \approx 0.125\%$  per layer



this is for inner tracker disks; probably similar for outer tracker disks (?)

## Technical Details



### Design details:

- **2 Sandwich panels [CFS-CORE-CFS]**
  - CFS RINGS: 0.48 mm → Woven Fabric, Ultra High Modulus Fibers M55JB 6K
  - CFS SPOKES: 0.48 mm → Carbon Fiber Laminate, Toray M55J
  - Core: 10mm → Rohacell IG51
- **2 Sets of rings on each side (in total 8 rings)**
  - Peek Rings: 4 mm
- **Horizontal Interlinks – Inner & Outer CF Shell**
  - CF SHELLS: 0.48 mm → Woven Fabric, Ultra High Modulus Fibers M55JB 6K
- **Radial Interlinks – CF Plates**
  - CF Plates: 0.8 mm → Carbon Fiber Laminate, Toray M55J